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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kwang Bok Song	04/18/1994
Sung Ki Kim	04/18/1994
Jin Sub Shim	04/18/1994

RECEIVING PARTY DATA

Name:	Crosstek Capital, LLC	
Street Address:	2711 Centerville Road	
City:	Wilmington	
State/Country:	DELAWARE	
Postal Code:	19808	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	08525951

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	21322US03
NAME OF SUBMITTER:	Peter J. McAndrews

Total Attachments: 2

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PATENT REEL: 023634 FRAME: 0355

MULTIPLE ASSIGNMENT:

ASSIGNMENT

WHEREAS, WE, Kwang Bok Song (Song is the last name), Sung Ki Kim (Kim is the last name), and Jin Sub Shim (Shim is the last name), the undersigned inventors and the ASSIGNORS herein, have invented a SOLID STATE IMAGE SENSING ELEMENT AND METHOD FOR FABRICATING THE SAME, for which we have filed application for Letters Patent of the United States, Serial No. 08/210,225 filed on March 17, 1994, which application was executed by each of us and of which inventions and improvements we are the joint owners; and

WHEREAS, GOLDSTAR ELECTRON CO., LTD., a corporation organized and existing under the laws of the Republic of Korea, having a place of business at 50 Hyangjeong-dong, Cheongju-si, Chungcheongbuk-do, Korea, the ASSIGNEE herein, desires to acquire the entire right, title and interest in and to said inventions, applications and Letters Patent to be granted and issued thereon;

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) by the ASSIGNEE to each of us paid, and other valuable consideration, the receipt and legal sufficiency of all of which is hereby acknowledged, we, the said ASSIGNORS, have sold and do hereby sell, assign, transfer and set over unto said ASSIGNEE, its successors and assigns, the entire right, title and interest in and to said inventions and all improvements thereon, in and to said application for Letters Patent thereon, in and to applications pertaining to or based upon said inventions and applications, including divisional and continuing applications and continuations—in—part, and in and to any and all Letters Patent which may be granted and issued on said inventions and applications, or any of them, not only for, to and in the United States of America, its territories and possessions, but for, to and in all countries foreign thereto, together with and including all priority rights based upon any and all applications in the United States of America covered by this Assignment.

And for the above-named considerations, we do hereby agree that we will, at the request of said ASSIGNEE, execute any and all applications for Letters Patent for said inventions and any and all other papers and documents and do all other and further lawful acts that said ASSIGNEE may deem necessary or desirable to obtain Letters Patent on said inventions, to secure the grant of such Letters Patent and to perfect and vest in the ASSIGNEE the entire right, title and interest in the inventions, applications and Letters Patent.

And for the above-named considerations, we do hereby authorize and empower the ASSIGNEE, its successors and assigns, to apply for and

PATENT REEL: 023634 FRAME: 0356 obtain, in its or their own names, Letters Patent for the said inventions before competent International Authorities and in any and all countries foreign to the United States in which applications for Letters Patent can be so made or Letters Patent so obtained.

Dated: 74. 4.18	Kurang Bod Gong
	Kwang Bok Song 264-142, Imun2-dong, Dongdaemun-ku Seoul, Korea
Dated: <u>84. 4,/8</u>	Sung Ki Kim 55-2, Hapjung-dong, Mapo-ku
	Seoul, Korea

Dated: 94. 4.18

Jin Sub Shim

Duk Won mansion 507 1425 Kwanyang-dong, Anyang-si Kyungki-do, Korea

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RECORDED: 11/19/2009